



/isit us Booth #50

Cutting-Edge Technology by MELEC GmbH HiPIMS Superimpose with DC or Mid.-Frequency





DC Pulse Power Controller SPIK3000A Industrial scale 5kW -90 kW DC AVERAGE POWER

HiPIMS • Mid.Frequency (MF) • DC

Motivation for HiPIMS acceptance in the industry

Highest depositionrate

- poisonina
- Highest process stability tuning; reproduceable
- Low cost retrofit applications, single magnetron
- HiPIMS in combination with DC or Mid-Frequency
- Reducing / preventing of arcing / HiPIMS used in pulse package mode
 - HiPIMS/MF used in bipolar pulse mode
 - Use of your existing DC power supply combined with HiPIMS

Improvements of coating using HiPIMS

- Higher ion bombardment
- Better coating adhesion
- Harder coating
- Denser films

Superimposed Processes for higher deposition rate • HiPIMS + DC

• HiPIMS + MF



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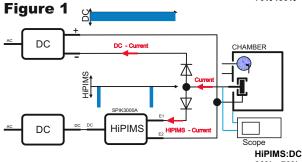
MELEC GmbH licensed SPIK3000A series production at the company SHEN CHANG in Taiwan





Superimpose HiPIMS applications

Electric Circuit Superimposed HiPIMS / DC using Single Magnetron



Electric Circuit Superimposed HiPIMS (UP) / MF using Single Magnetron

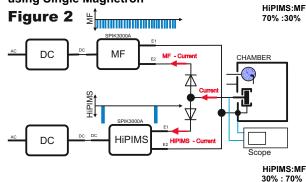




Figure 1

The basic electric circuit shows the different paths of DC-current and HiPIMS-current depending on the different voltage levels (DC = constant; HiPIMS = f(t)). The gate-way of the two diodes is synchronized automatically by themselves because of the condition:

DC-V < HiPIMS-V f(t)

HiPIMS combined with DC generates in the NON REACTIVE SPUTTERING MODE highest depositions rates

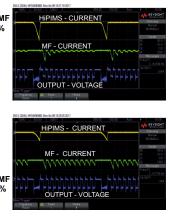


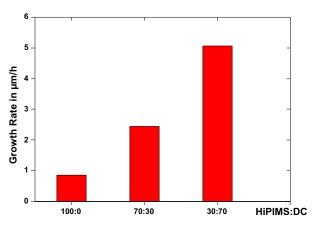
Figure 2

The basic electric circuit shows the different ways of Mid.Freq.-current and HiPIMScurrentdepending on the different voltage levels (Mid.-Freq.-voltage = f(t); HiPIMS-voltage = f(t)). The gate-way of the two diodes is synchronized automatically by themselves because of the condition:

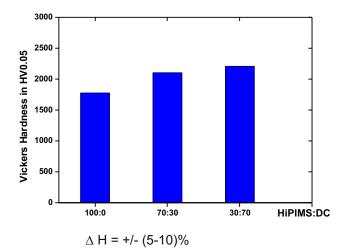
Mid.-Freq.-V f(t) < HiPIMS-V f(t)

HiPIMS combined with Mid.-Freq. generates in the REACTIVE SPUTTERING MODE highest depositions rates, prevents arcing and poisoning.

Ti-N Depositions Rate and Hardness



- HiPIMS+DC total power: 5 kW
- HiPIMS duty cycle 9.1%, Frequency 1818 Hz
- Titarget
- Working Gas: Ar(300sccm) N2(14sccm)
- without Substrate Rotation



ZIM

Some projects and collaborations were supported by

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of Economics

and Technology









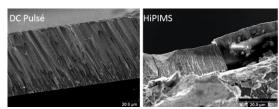


DEPHIS 74 Rue Armand Japy 25460 ETUPES France +33 3 81 95 44 01 www.dephis.com contact@dephis.com DEPHIS specializes in the production and R&D of innovative thin-film coatings using various Vapor Deposition techniques (Dc-P, Arc, CVD, RF, HiPIMS).

DEPHIS also specializes in the development and fabrication of Vapor Deposition Machines utilizing the DC-P, Arc, CVD, RF, HiPIMS technologies or a hybridization of multiple techniques.

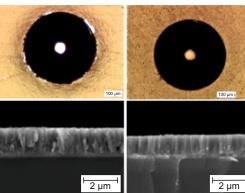
picture 3

picture 1



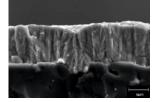
Fractography comparing two coatings made by HiPIMS and DC Pulsé traditional

picture 4



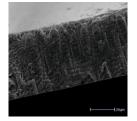
Pulsed DC coating HiPIMS coating Comparison of coatings with different process - HiPIMS VS DC.

picture 2

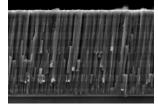


Fractography of a columnar alloy on Alumina substrate

picture 5



Fractography of an iron alloy (e.g. Fe-Si, Fe-Mg, Fe-C, Fe-Co...) coating on a glass for astrophysic applications.



Fractography and cross-sectional view of a multilayer metal-ceramic coating for aerospace applications



picture 8

Prototype reactor for the production of large components. This prototype is equipped with the magnetron shown in picture 9





picture 7



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P9/P10: DEPHIS' latest hybrid coating reactor the TriProS, which combines the HiPIMS, Arc, CVD, DC-P technologies into a single cost effective machine. The machines is equipped with SPIK3000A generators in a bipolar configuration.



picture 9 Example of a 30kW HiPIMS plasma produced by a 5.04m long magnetron fabricated by DEPHIS.

Source: Text and pictures released by DEPHIS





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